

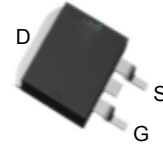
## Features

- 30V/150A,  
 $R_{DS(ON)} = 1.7\text{m}\Omega(\text{typ.}) @ V_{GS}=10\text{V}$   
 $R_{DS(ON)} = 2.2\text{m}\Omega(\text{typ.}) @ V_{GS}=4.5\text{V}$
- 100% UIS +  $R_g$  Tested
- Reliable and Rugged
- Lead Free and Green Devices Available  
(RoHS Compliant)

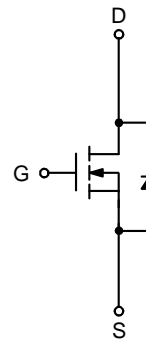
## Applications

- Power Management in Secondary Rectifier For SMPS.

## Pin Description



Top View of TO-263-2



N-Channel MOSFET

**Absolute Maximum Ratings** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
<b>Common Ratings</b>			
$V_{DSS}$	Drain-Source Voltage	30	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	
$I_S$	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ 32	A
$I_{DP}^b$	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$ 200	A
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$ 150 <sup>a</sup>	A
		$T_C=100^\circ\text{C}$ 90	
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 100	W
		$T_C=100^\circ\text{C}$ 40	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	1.2	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62.5	
$E_{AS}^c$	Avalanche Energy, Single Pulsed	$L=0.1\text{mH}$ 460	mJ

Note a : Max. continuous current is limited by bonding wire. Silicon limited current is 125A base on max. junction temperature.

Note b : Pulse width limited by max. junction temperature.

Note c : UIS tested and pulse width limited by maximum junction temperature  $150^\circ\text{C}$  (initial temperature  $T_J=25^\circ\text{C}$ ).

**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)

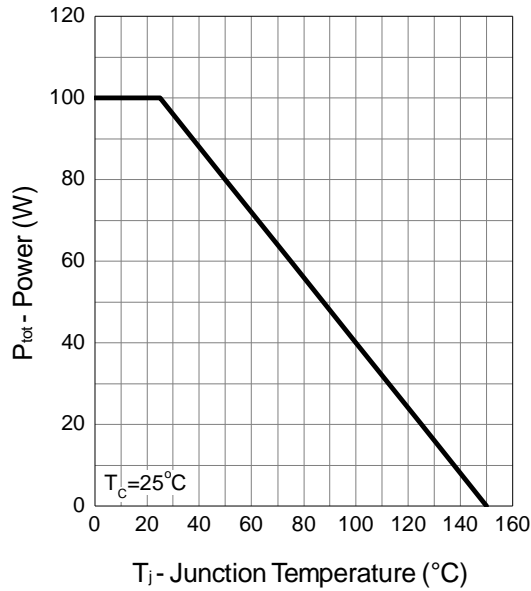
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	30	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=24V, V_{GS}=0V$	-	-	1	$\mu A$
		$T_J=85^\circ C$	-	-	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	1.3	-	2.5	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
$R_{DS(ON)}^d$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=40A$	-	1.7	2.2	m $\Omega$
		$V_{GS}=4.5V, I_{DS}=32A$	-	2.2	3.5	
<b>Diode Characteristics</b>						
$V_{SD}^d$	Diode Forward Voltage	$I_{SD}=32A, V_{GS}=0V$	-	0.8	1.1	V
$t_{rr}$	Reverse Recovery Time	$I_{SD}=40A, di_{SD}/dt=100A/\mu s$	-	27	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	15	-	nC
<b>Dynamic Characteristics<sup>e</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	-	1.4	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=15V,$ Frequency=1.0MHz	-	2450	-	$\mu F$
$C_{oss}$	Output Capacitance		-	520	-	
$C_{rss}$	Reverse Transfer Capacitance		-	240	-	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=15V, R_L=15\Omega,$ $I_{DS}=1A, V_{GEN}=10V,$ $R_G=6\Omega$	-	20	37	ns
$t_r$	Turn-on Rise Time		-	16	30	
$t_{d(OFF)}$	Turn-off Delay Time		-	48	87	
$t_f$	Turn-off Fall Time		-	21	39	
<b>Gate Charge Characteristics<sup>e</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=15V, V_{GS}=10V,$ $I_{DS}=40A$	-	43	-	nC
$Q_g$	Total Gate Charge	$V_{DS}=15V, V_{GS}=4.5V,$ $I_{DS}=40A$	-	25	-	
$Q_{gs}$	Gate-Source Charge		-	7.3	-	
$Q_{gd}$	Gate-Drain Charge		-	12.3	-	

Note d : Pulse test ; pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ .

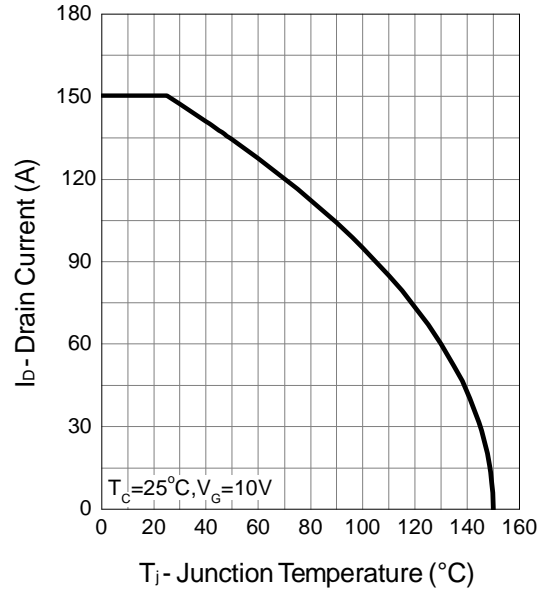
Note e : Guaranteed by design, not subject to production testing.

### Typical Operating Characteristics

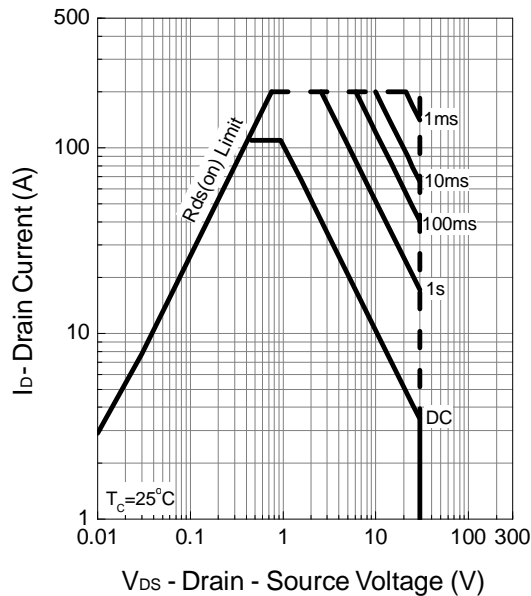
**Power Dissipation**



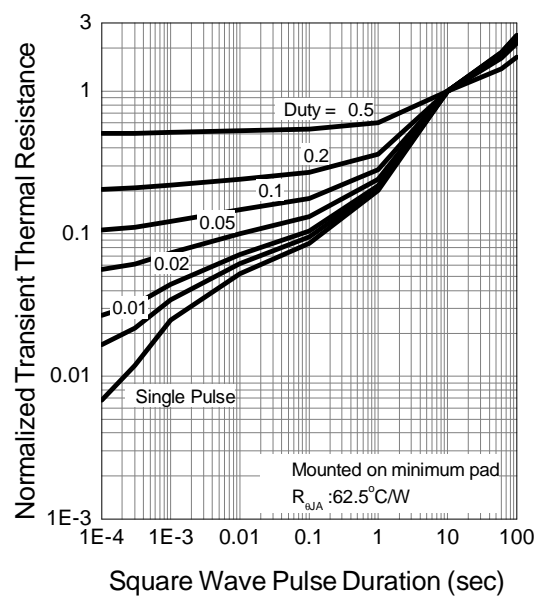
**Drain Current**

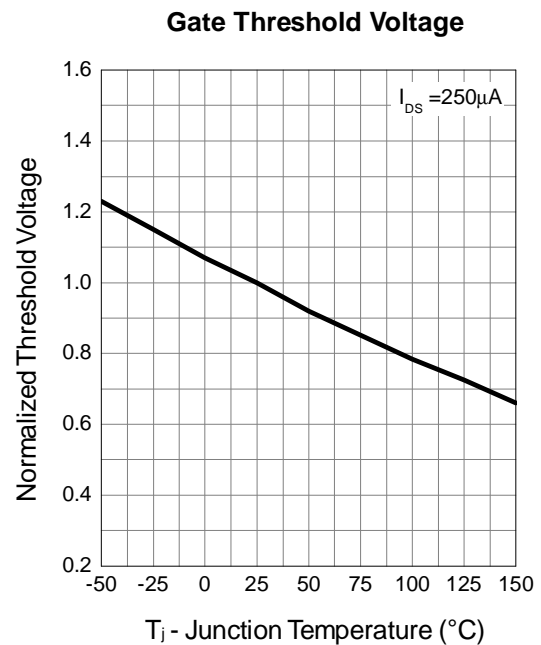
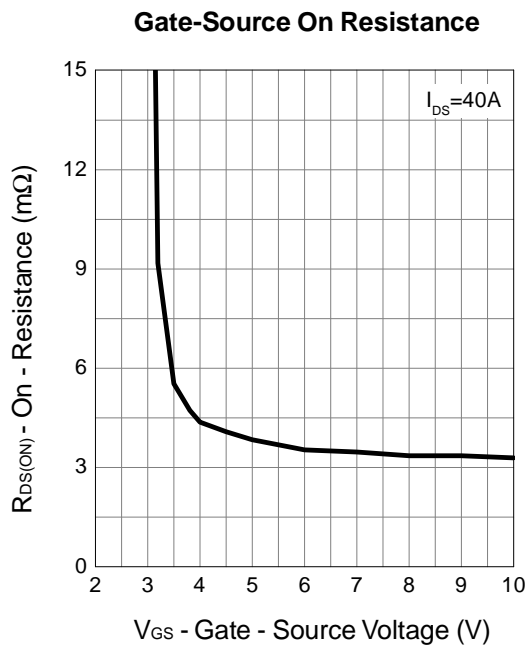
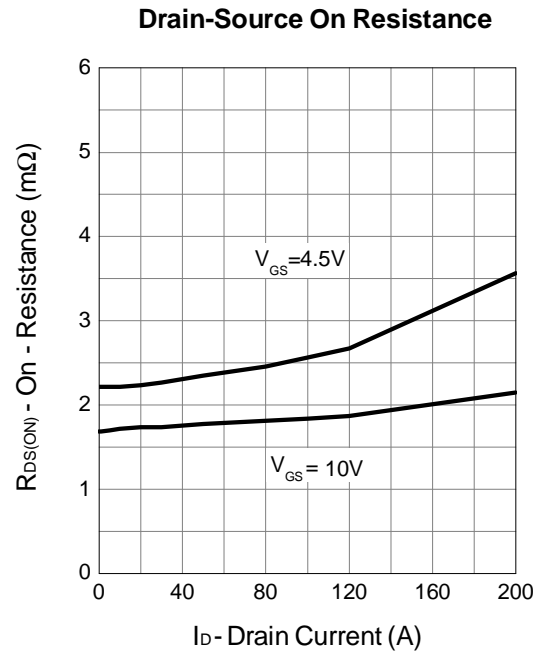
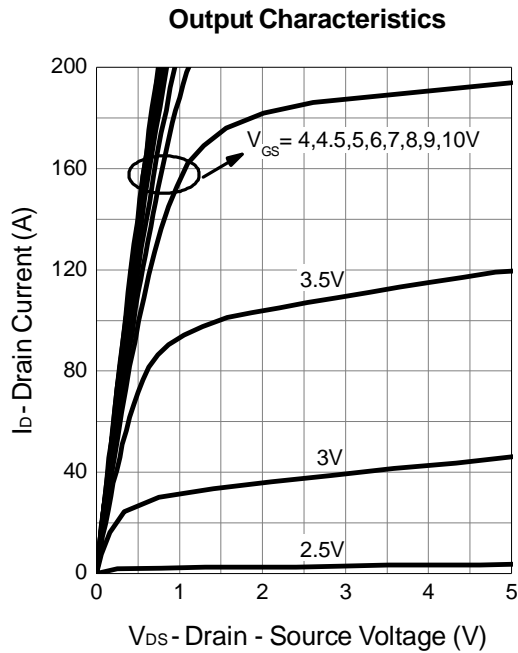


**Safe Operation Area**



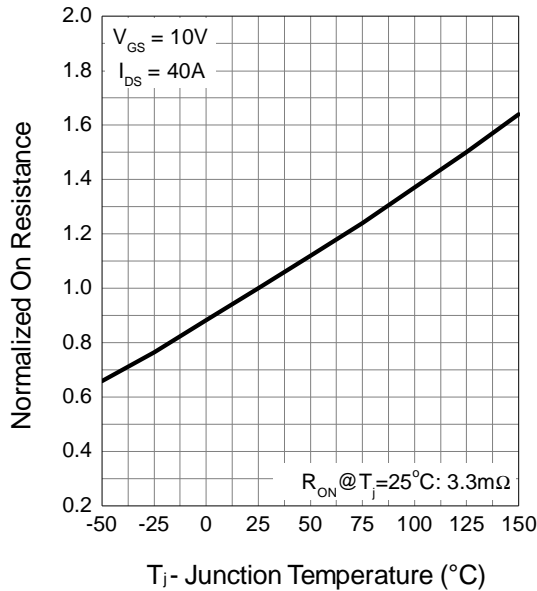
**Thermal Transient Impedance**



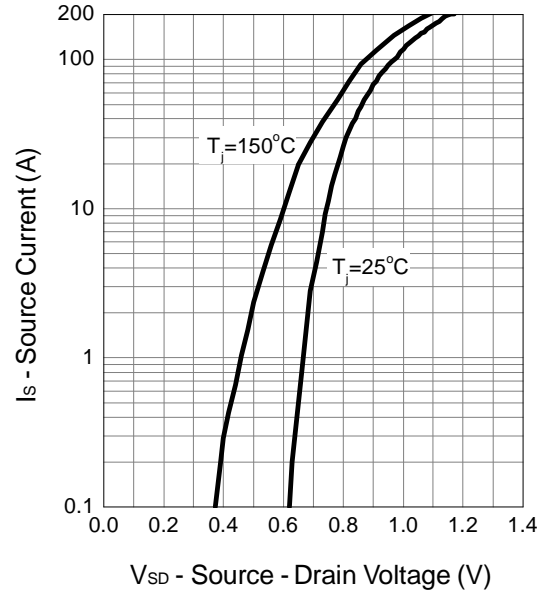
**Typical Operating Characteristics (Cont.)**


### Typical Operating Characteristics (Cont.)

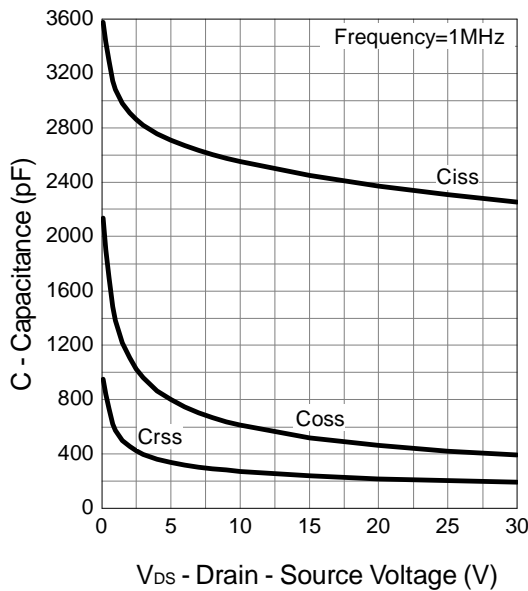
**Drain-Source On Resistance**



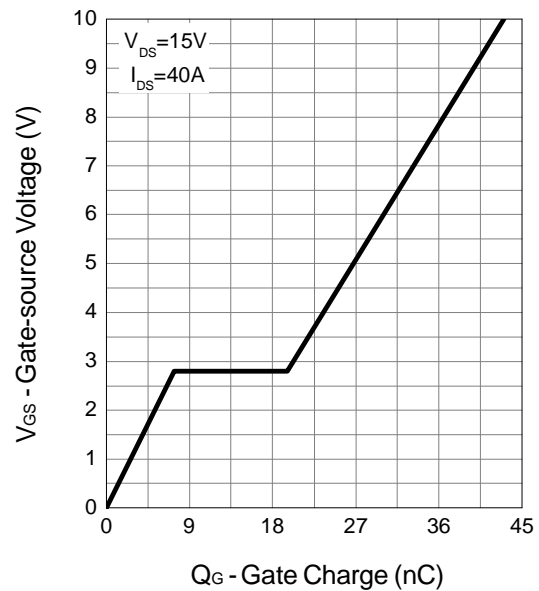
**Source-Drain Diode Forward**



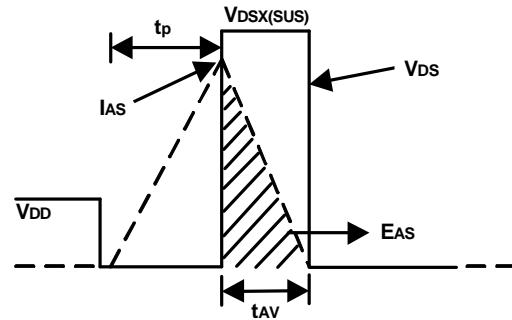
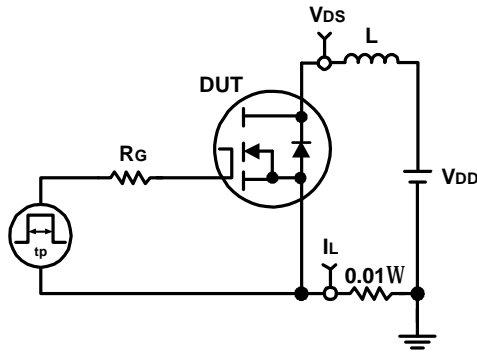
**Capacitance**



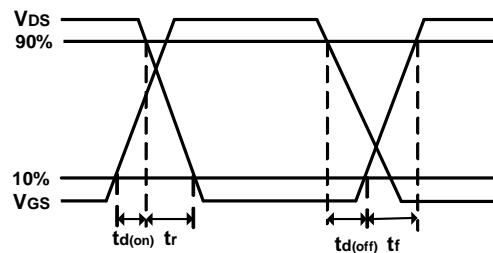
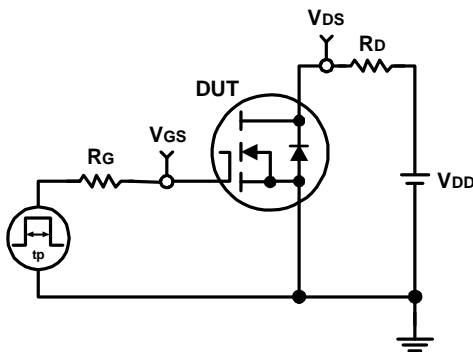
**Gate Charge**



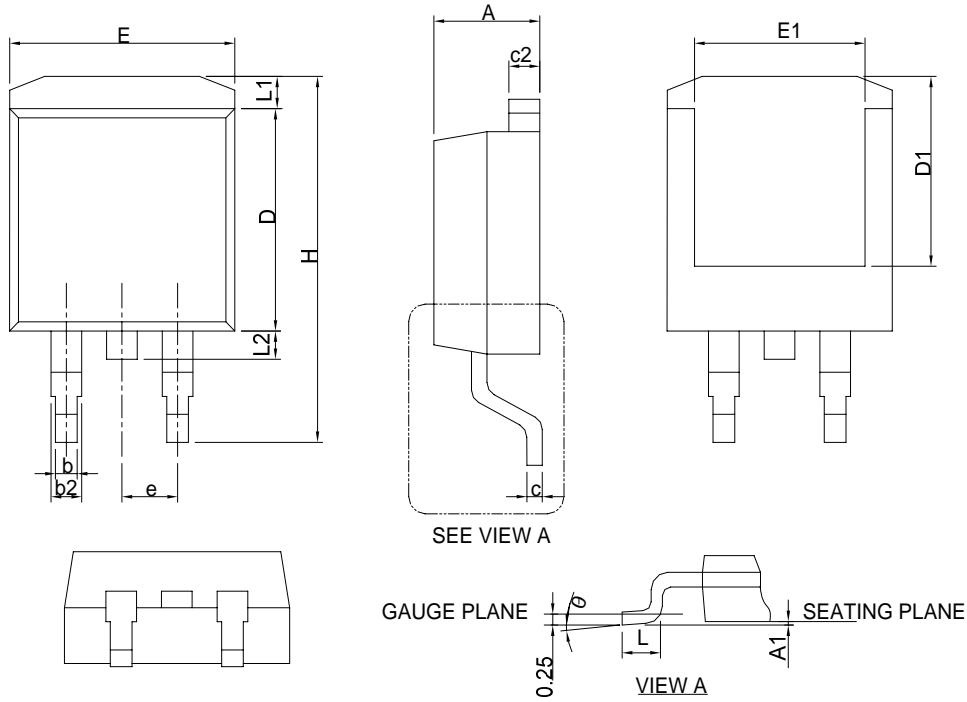
### Avalanche Test Circuit and Waveforms



### Switching Time Test Circuit and Waveforms



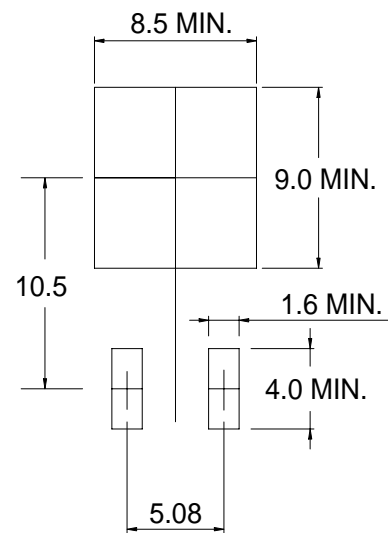
## Package Information

**TO-263-2**


SYMBOL	TO-263-2			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b2	1.14	1.78	0.045	0.070
c	0.38	0.74	0.015	0.029
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380
D1	6.00	9.00	0.236	0.354
E	9.65	11.43	0.380	0.450
E1	6.22	9.00	0.245	0.354
e	2.54 BSC		0.100 BSC	
H	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.68	-	0.066
L2	-	1.78	-	0.070
θ	0°	8°	0°	8°

Note : Follow JEDEC TO-263 AB.

### RECOMMENDED LAND PATTERN



UNIT: mm